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Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)				Application Number	09/731,891
				Filing Date	12/6/00
				First Named Inventor	Steven Teig
				Group Art Unit	2825
				Examiner Name	Thuan Do
				Attorney Docket Number	SPLX.P0002
Sheet	1	of	3		

U.S. PATENTS RELATED TO THE PRESENT APPLICATIONS						
Examiner* Initials	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication MM-DD-YYYY	Relation to Present Application
		Number	Kind Code ² (if known)			
TD	1.	6,516,455	B1	Teig, et al.	02-10-02	CIP of the present application

U.S. PATENT DOCUMENTS						
Examiner* Initials	Cite No. ¹	U.S. Patent Document Number	Kind Code ² (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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Examiner Signature		Date Considered	6-4-03
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First Named Inventor

Steven Teig

Group Art Unit

2825

Examiner Name

Thuan Do

Attorney Docket Number

SPLX.P0002

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		Office ³	Number ⁴	Kind Code (if known) ⁵				
TD	40.	JP	64-15947		Ouchi	01-19-89		

NON PATENT LITERATURE DOCUMENTS

Examiner* Initials	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ⁶
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Examiner
Signature

Thuan Do

Date
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Examiner Signature	<i>Muanda</i>	Date Considered	6/4/03
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